



*... for a brighter future*

# ***DEVELOPMENT OF NONDESTRUCTIVE EVALUATION METHODS FOR THERMAL BARRIER COATINGS***

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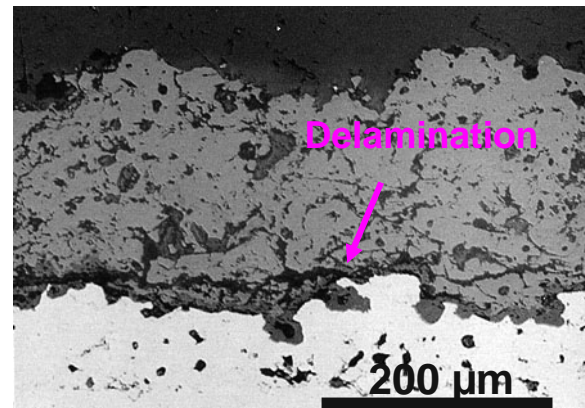
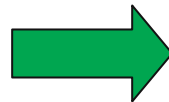
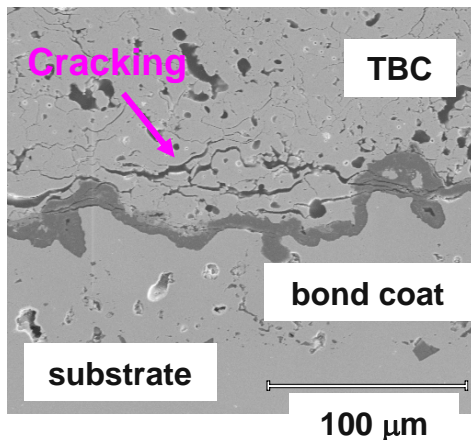
***Work supported by U.S. Department of Energy,  
Office of Fossil Energy,  
Advanced Research-Materials Program***

# Outline

- Background
- NDE technologies and typical results
  - Optical methods
    - *TBC thickness*
  - Thermal imaging methods
    - *TBC thickness and thermal property*
- Summary
- Planned future efforts

## Background

- Thermal barrier coatings (TBCs) are “prime reliant” material for turbine engine components – evaluation of their conditions by NDE is important
- NDEs may be used to:
  - Assess TBC process reliability and product quality (specs, defects, etc)
    - *Current TBC processing relies on robust process conditions*
  - Monitor TBC degradation and predict TBC lifetime
    - *TBC degradation mechanism: crack initiation near TBC/bond coat interface → TBC delamination → TBC spallation (failure)*



Top coat  
spallation  
(failure)

## Background - continued

- Current NDE methods are not suitable for quantitative TBC evaluation
  - Optical methods; eddy current; impedance spectroscopy; thermal spectroscopy; thermal imaging, etc
    - *qualitative, semi-empirical, point detection-not suitable for full field imaging*
- NDE development at ANL is focused on quantitative methods that can be used for fundamental TBC property/condition studies and for field monitoring/prediction of TBC degradation and lifetime
  - Quantitative determination of TBC thickness and thermal conductivity which are two of the most important parameters for TBC quality and degradation
    - *They determine the substrate surface temperature*
- NDE methods developed under this project - 2D and 3D imaging technologies:
  - Optical methods: for TBC thickness and degradation/delamination
    - *For EB-PVD and thin APS TBCs (without surface contamination)*
  - Thermal imaging methods: for TBC thickness and conductivity (degradation/delamination)
    - *Not limited by TBC thickness and surface contamination*
    - *Can be applied to other coating and multilayer systems*

# NDE Technologies for TBCs

## ■ Optical methods

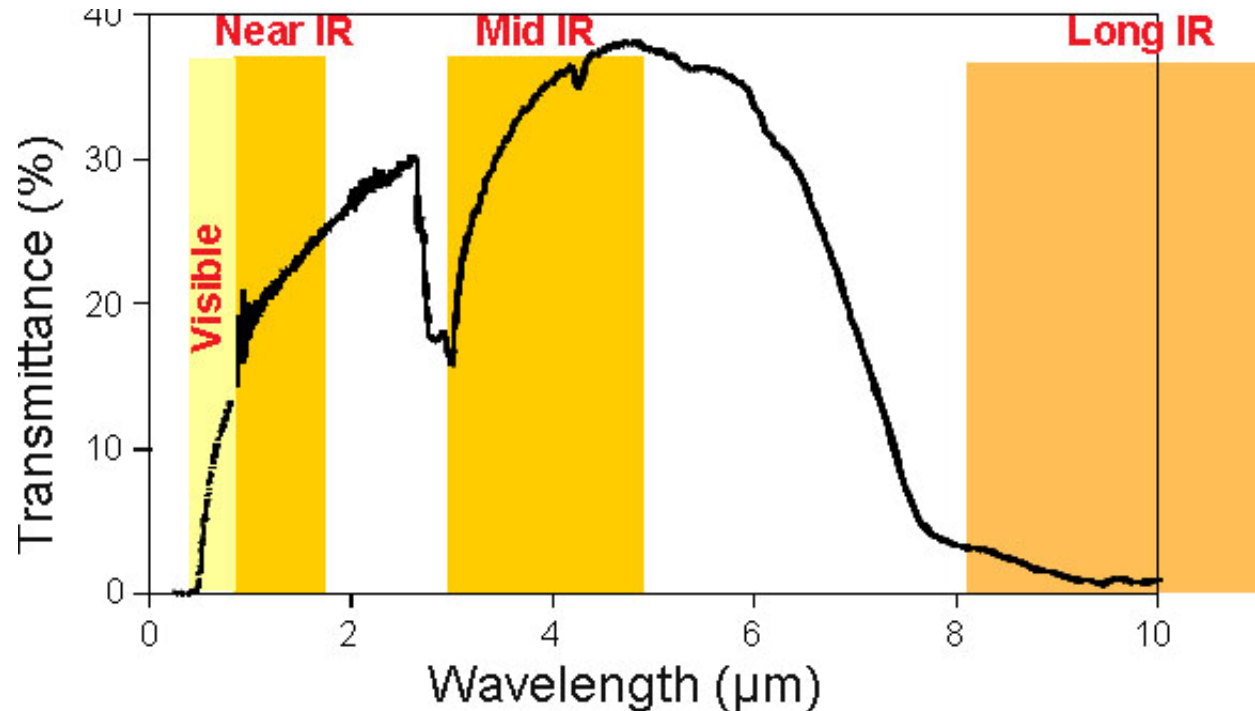
- 3D optical coherence tomography (OCT)
  - *TBC thickness*
  - *3D TBC microstructure (and cracking)*
- 2D laser backscatter
  - *TBC degradation (cracking and delamination)*

## ■ Thermal imaging methods

- 2D thermal multilayer modeling:
  - *TBC thickness and conductivity distribution*
  - *TBC cracking and delamination*
- 3D Thermal tomography:
  - *TBC thickness & thermal property distribution in 3D*
  - *3D TBC structure (e.g., crack depth and size distribution within TBC layer)*

# Typical Optical Transmission Property of TBC

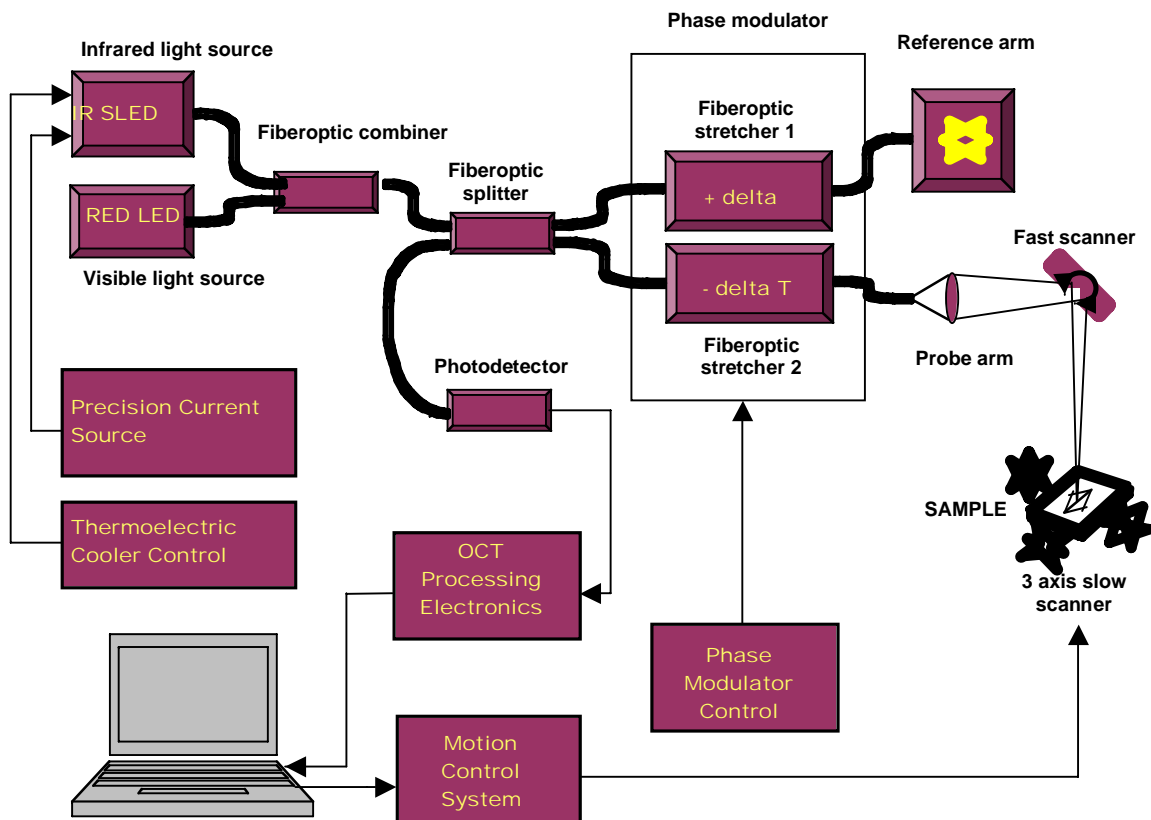
Hemispherical Transmittance of a 172-micron-thick TBC (APS-8YSZ)



From J.I. Eldridge, C.M. Spuckler, J.A. Nesbitt, and K.W. Street, "Health Monitoring of thermal barrier coatings by mid-infrared reflectance," presented in 2003 Cocoa Beach Conference

- Optical methods can detect TBC condition up to TBC/bond coat interface
- Deeper penetration when using infrared light
- This optical translucency is a problem for thermal imaging methods

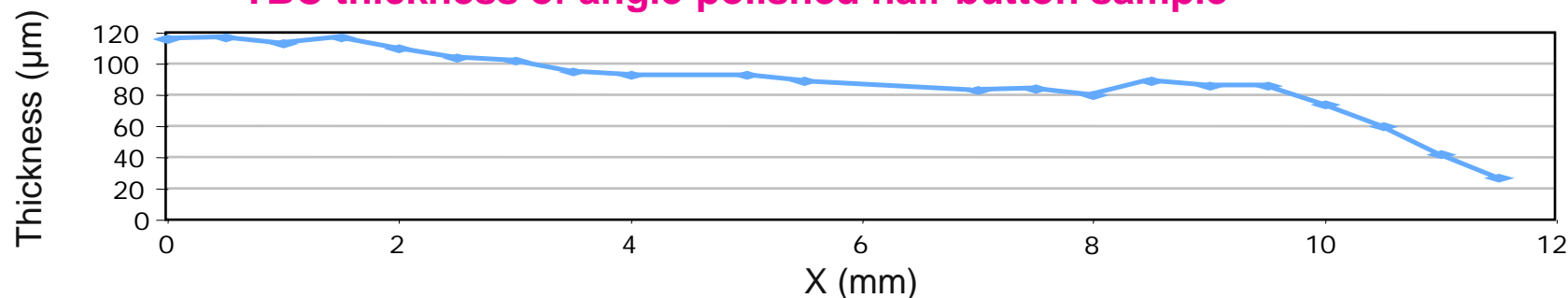
# Schematic of ANL's OCT System



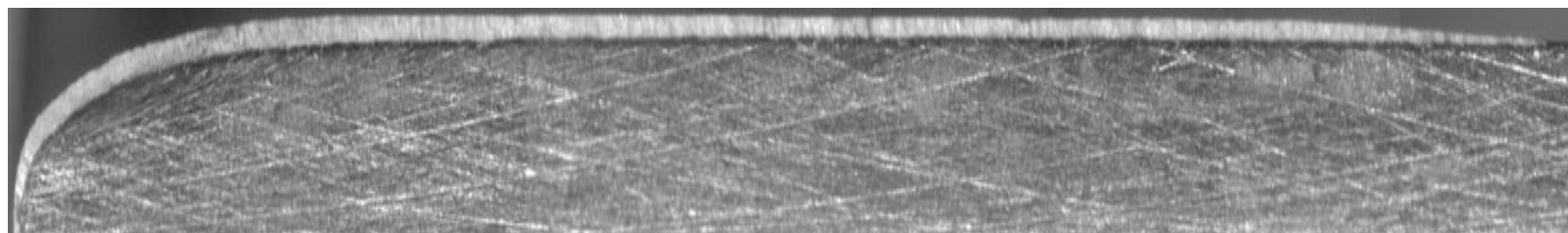
- Interference for depth resolution; laser spot scanning for lateral resolution
- 3D imaging with typical resolution  $\sim 10\mu\text{m}$  in all dimensions
- Near IR light source, relatively deeper penetration depth
- Well developed method

# OCT result for an angle-polished EB-PVD TBC

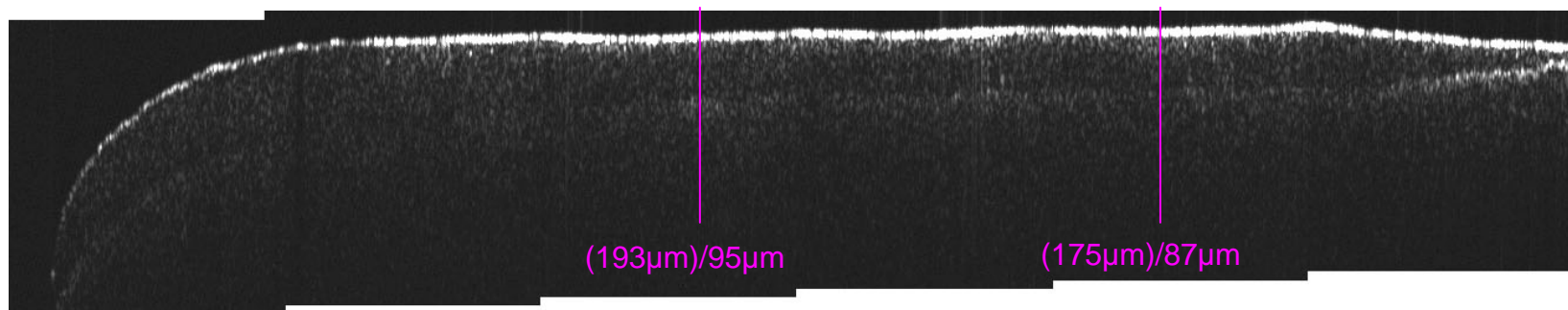
TBC thickness of angle-polished half-button sample



Photomicrograph of TBC sample edge (Aspect ratio: 1:2)



OCT Image near TBC sample edge (TBC refraction index = 2.04)



■ May detect cracks within TBC



# NDE Technologies for TBCs

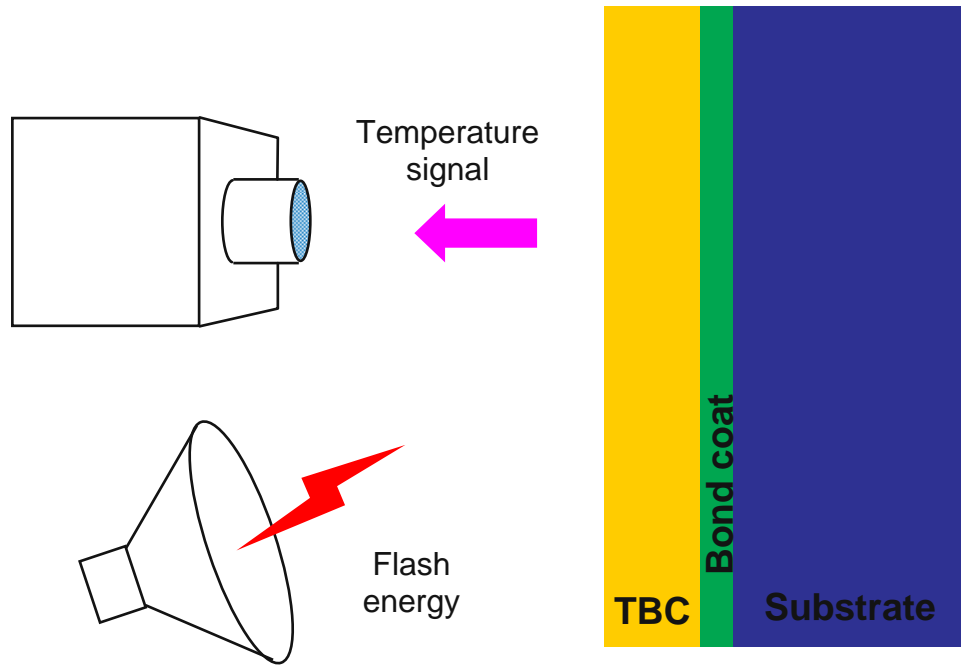
## ■ Optical methods

- 3D optical coherence tomography (OCT)
  - *TBC thickness*
  - *3D TBC microstructure (and cracking)*
- 2D laser backscatter
  - *TBC degradation (cracking and delamination)*

## ■ Thermal imaging methods

- 2D thermal multilayer modeling:
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  - *TBC thickness & thermal property distribution in 3D*
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# Thermal Imaging Methods – Based on 1-Sided Flash Setup



Thermal conductivity:

TBC:  $k \sim 1 \text{ W/m/}^\circ\text{C}$

Bond coat: (similar as substrate)

Substrate:  $k \sim 10 \text{ W/m/}^\circ\text{C}$

Air:  $k = 0.024 \text{ W/m/}^\circ\text{C}$

(fills cracks when they exist)

- High detection sensitivity due to large disparity of thermal properties at each layer
- Imaging method, fast (few to few tens seconds) for 100% surface inspection
- New 2D and 3D methods are developed at Argonne National Laboratory

# TBC Parameters Measurable by Flash Thermal Imaging

- Transient heat transfer equation (1D):

$$\rho C_p \frac{\partial T}{\partial t} = k \frac{\partial^2 T}{\partial z^2}$$

- Parameters in the equation:

- TBC material properties:  $\rho C_p$  – heat capacity;  $k$  – thermal conductivity
- Length scale: TBC thickness (L)
- Temperature scale: based on experimental maximum-minimum
- Time: measured in experimental data

- Therefore, three parameters are relevant in transient thermal test:  $\rho C_p$ ,  $k$ , and L. Can they be independently determined from flash thermal imaging test?

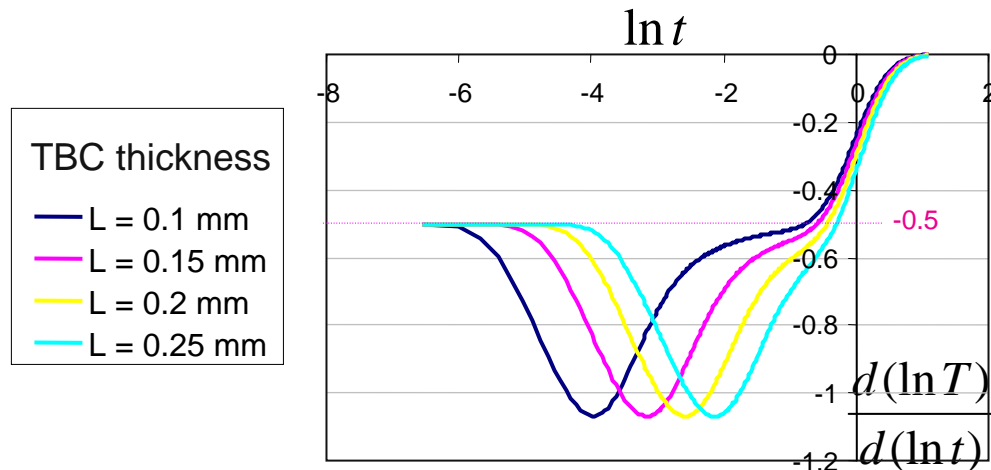
- Note:  $\rho C_p$  and  $k$  can be converted to another two thermal parameters:

- Thermal diffusivity  $\alpha = k/\rho C_p$
- Thermal effusivity  $e = (k\rho C_p)^{1/2}$
- Any two of these four parameters are independent

# Analysis of thermal imaging response to TBC parameters

## -- TBC thickness $L$

- Plot of surface temperature decay slope vs. time in log-log scale
  - Simulated data for pulse thermal imaging of TBC specimens
    - TBC:  $L = \text{varies}$ ,  $k = 1.5 \text{ W/m-K}$ ,  $\rho C_p = 2.5 \text{ J/cm}^3\text{-K}$
    - Substrate:  $L = 3\text{mm}$ ,  $k = 11$ ,  $\rho C_p = 3.5$



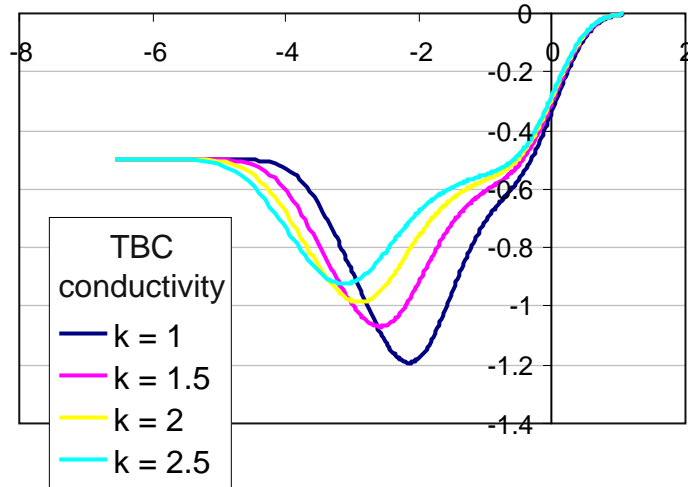
- TBC thickness determines the time when slope deviates from initial value of -0.5

# Analysis of thermal imaging response to TBC parameters -- TBC conductivity $k$ and heat capacity $\rho C_p$

Variation in TBC conductivity:

TBC:  $L = 0.2\text{mm}$ ,  $k = \text{varies}$ ,  $\rho C_p = 2.5 \text{ J/cm}^3\text{-K}$

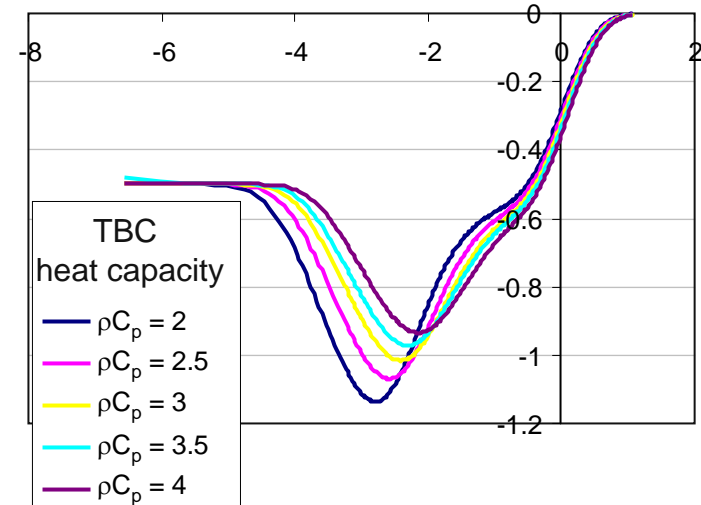
Substrate:  $L = 3\text{mm}$ ,  $k = 11$ ,  $\rho C_p = 3.5$



Variation in TBC heat capacity:

TBC:  $L = 0.2\text{mm}$ ,  $k = 1.5 \text{ W/m-K}$ ,  $\rho C_p = \text{varies}$

Substrate:  $L = 3\text{mm}$ ,  $k = 11$ ,  $\rho C_p = 3.5$



- Response of thermal imaging data to TBC conductivity & heat capacity is not distinct and separable

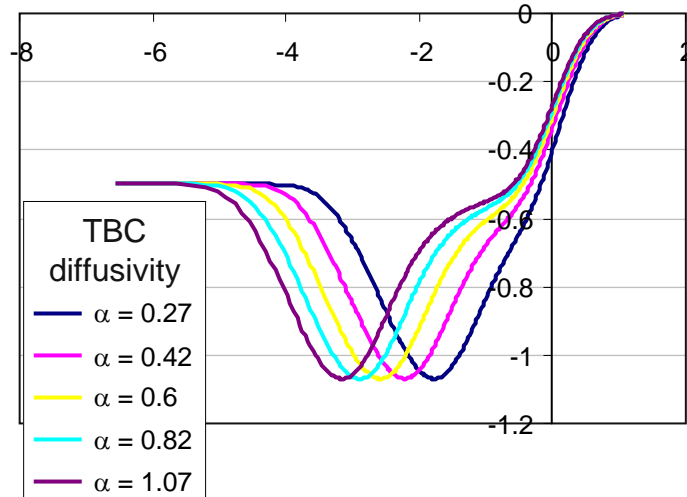
# Analysis of thermal imaging response to TBC parameters

## -- TBC diffusivity $\alpha$ and effusivity $e$

Variation in TBC diffusivity  $\alpha$ :

TBC:  $L=0.2\text{mm}$ ,  $\alpha = \text{varies}$ ,  $e = 3.75 \text{ J/m}^3\text{-K-s}^{1/2}$

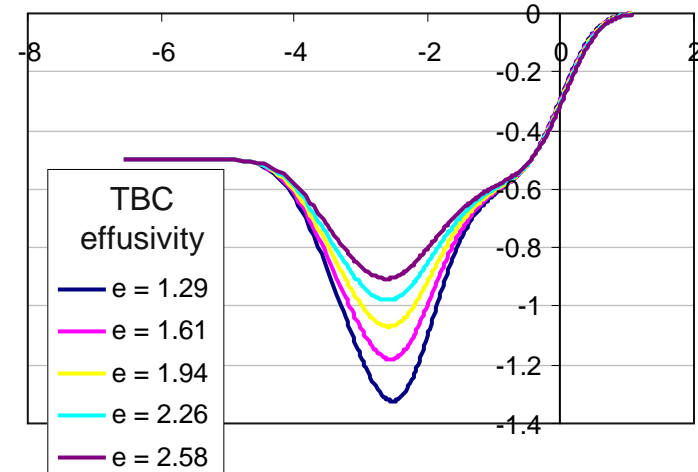
Substrate:  $L = 3\text{mm}$ ,  $k=11$ ,  $\rho C_p=3.5$



Variation in TBC effusivity  $e$ :

TBC:  $L=0.2\text{mm}$ ,  $\alpha = 0.6 \text{ mm}^2/\text{s}$ ,  $e = \text{varies}$

Substrate:  $L = 3\text{mm}$ ,  $k=11$ ,  $\rho C_p=3.5$



- Response of thermal imaging data to TBC diffusivity  $\alpha$  is similar to TBC thickness! In fact,  $\alpha t/L^2$  is a nondimensional parameter, and  $\alpha$  and  $L$  cannot be individually determined in thermal imaging test for single-layer specimen
- TBC effusivity  $e$  affects only the maximum slope value, i.e, independent of  $L$  or  $\alpha$

# Thermal Imaging Measurement for TBC parameters

- Among two TBC thermal properties and the TBC thickness, total of three parameters, only two can be determined independently by flash thermal imaging
- Thermal imaging (multilayer-modeling method) can determine/image:
  - (a) TBC thickness  $L$  with known TBC thermal properties  $k$  and  $\rho C_p$
  - (b) TBC thermal properties  $k$  and  $\rho C_p$  with known TBC thickness  $L$
  - (c) TBC conductivity  $k$  and thickness  $L$  with know TBC heat capacity  $\rho C_p$ 
    - *Work for this development is underway*
- Thermal imaging (tomography method) can image:
  - TBC effusivity  $e$  distribution (3D) as a function of  $\text{depth}$  (related to TBC diffusivity  $\alpha$ )

## ■ Optical methods

- 3D optical coherence tomography (OCT)
  - *TBC thickness*
  - *3D TBC microstructure (and cracking)*
- 2D laser backscatter
  - *TBC degradation (cracking and delamination)*

## ■ Thermal imaging methods

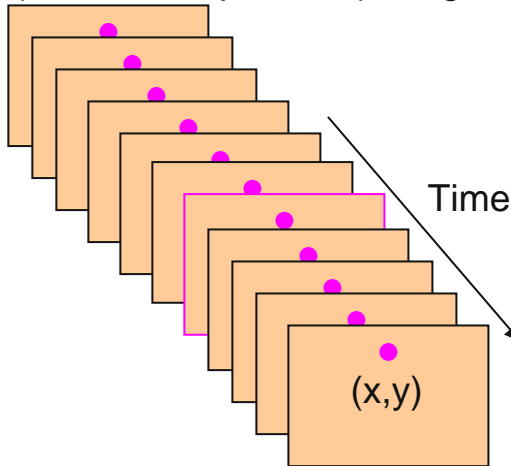
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  - *3D TBC structure (e.g., crack depth and size distribution within TBC layer)*



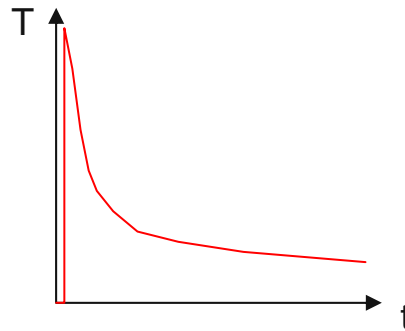
# 2D Thermal Multilayer Modeling for TBC Systems

## Measured data $T(x,y,t)$ :

Time series of 2D thermal  
(surface temperature) images



Surface temperature  
variation at pixel  $(x,y)$

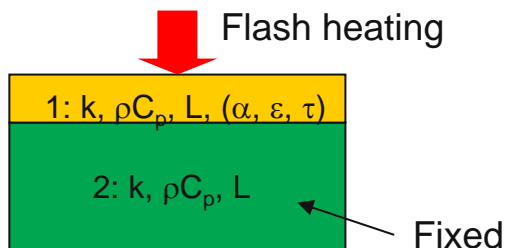


- Fitting numerical  
result with exp. data  
to derive correct  
TBC parameters:

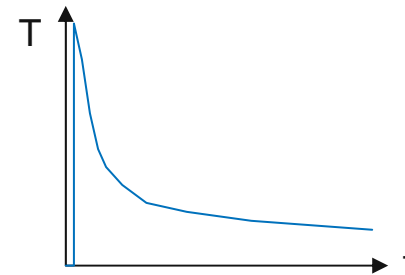
Coating 1:  
 $k, (\rho C_p), L, (\alpha, \varepsilon, \tau)$

Substrate 2:  
fixed properties

## Multilayer TBC model



Numerical solution of  
surface temperature variation



- Repeat this process  
for every pixel

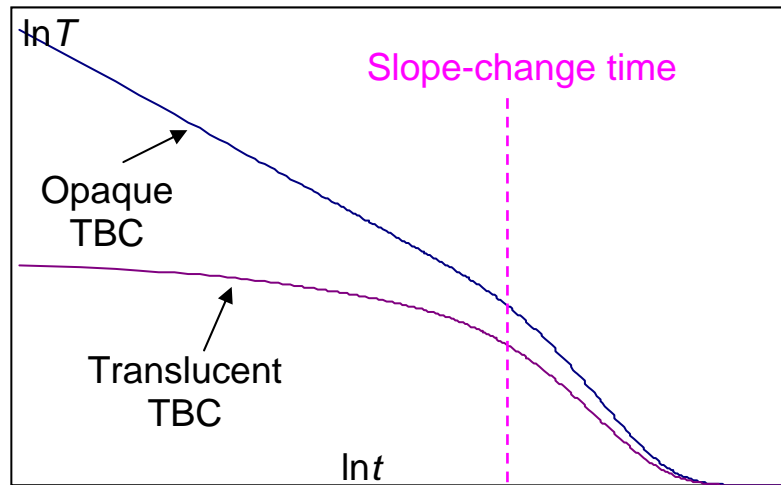
# *Analytical Thermal Imaging Model for Multilayer Materials*

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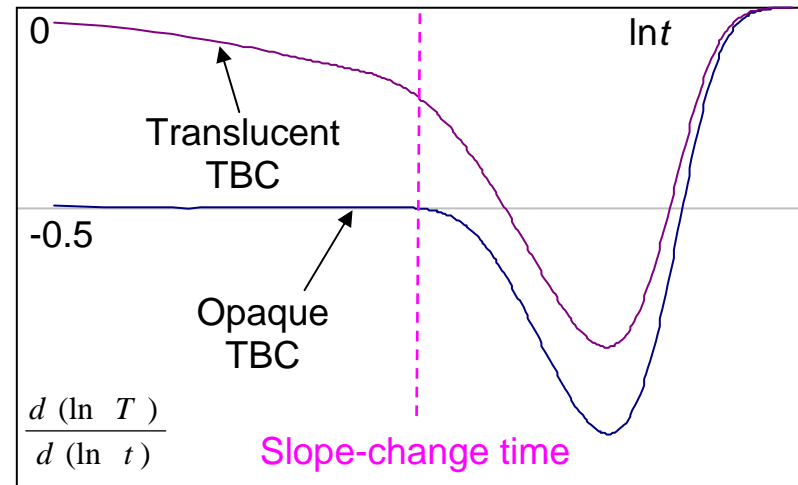
- Numerical solution of governing heat transfer equation for multilayer TBC materials
  - Crank-Nicolson scheme - 2nd order in both time and space
  - with finite flash duration, finite absorption depth, finite imaging depth
- Automated procedure for prediction of TBC parameters
  - At each pixel, measured surface temperature is fitted with numerical solutions to obtain a least-square fit which determines correct TBC parameters: thermal conductivity, thickness, and absorption coefficient
  - Process all pixels to determine distributions of the parameters
- For multilayer materials, parameters in each layer include:
  - thermal conductivity  $k$ ,
  - heat capacity  $\rho C_p$ ,
  - layer thickness  $L$ ,
  - and for translucent materials, the “absorption coefficient”
- This method can be used for any multilayer materials with any number of parameters

# Translucent (natural) and opaque (black-coated) TBCs

Temperature vs. time



Temperature slope vs. time



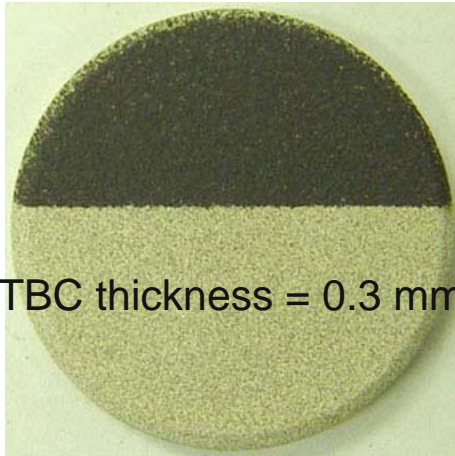
## Two-layer TBC



- TBC thickness is related to the slope-change time
- TBC translucency is related to initial slope

# TBC Thickness Distribution by Multilayer Modeling Method

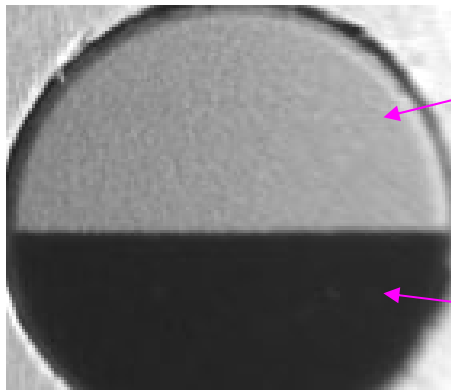
1"-dia TBC sample partially coated with a black paint



Sample courtesy of Dr. A. Kulkarni, Siemens

TBC thickness = 0.3 mm

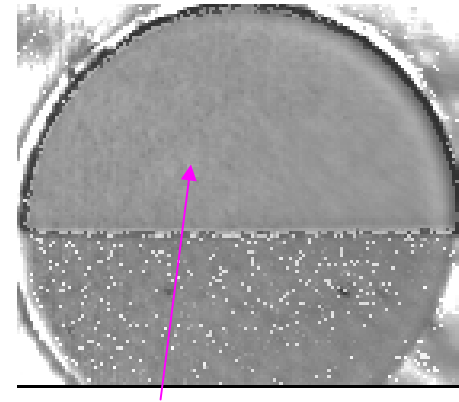
Typical thermal image after flash



Coated region has high temperature

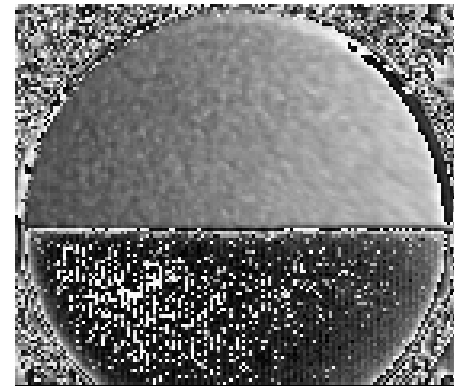
Uncoated region has low temperature

Predicted thickness map



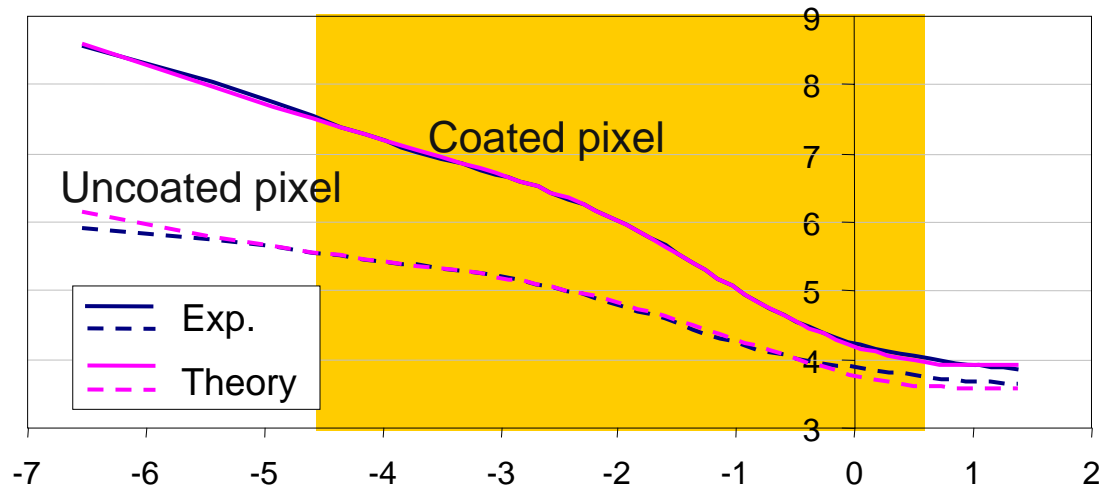
Average thickness = 0.302 mm

Predicted optical attenuation coefficient map

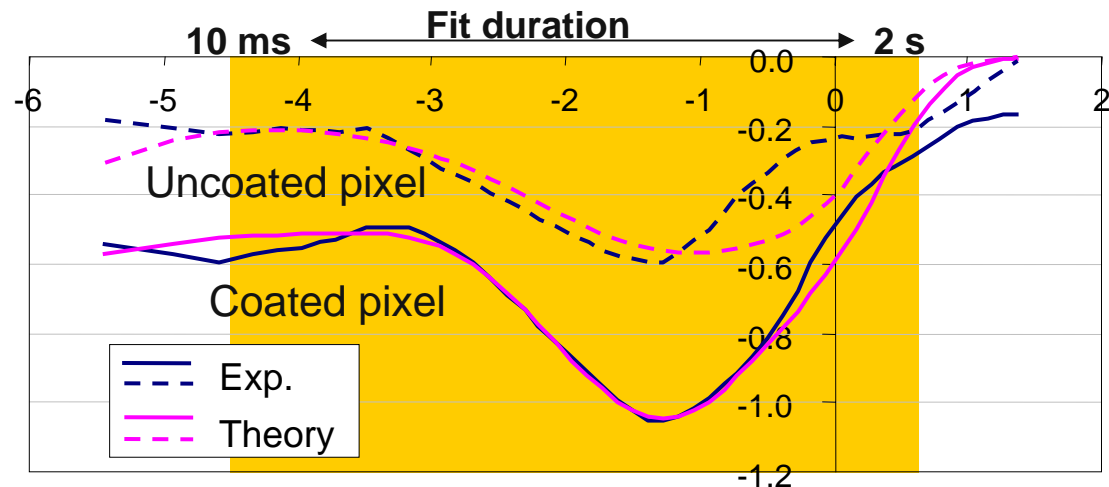


# Typical Fitting Results

Temperature vs. time (log-log scale)



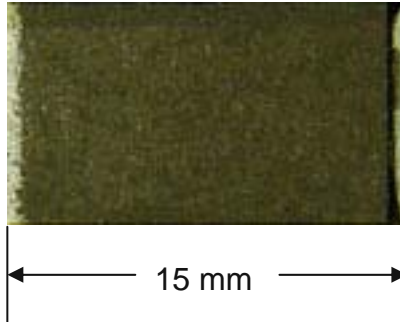
Temperature slope vs. time (linear-log scale)



■ Poor fit in uncoated pixel due to inadequate optical transmission model

# Multilayer thermal modeling for TBC thermal properties

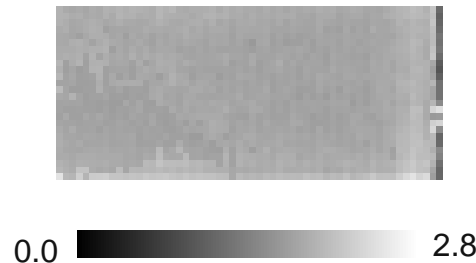
EBPVD TBC sample



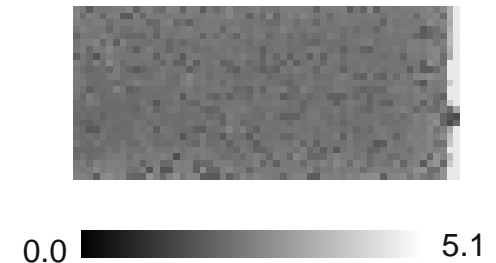
- As-processed TBC, 0.2 mm thick
- TBC was coated by a black paint

Sample courtesy  
of Mr. A. Luz,  
Imperial College  
London

TBC conductivity  $k$   
(W/m-K)



TBC heat capacity  $\rho C_p$   
(J/cm<sup>3</sup>-K)



- Average TBC conductivity: 1.8 W/m-K (high?)
- Average TBC heat capacity: 2.2 J/cm<sup>3</sup>-K
- TBC thickness  $L = 0.2\text{mm}$  is fixed in the analysis
- Substrate (Inconel superalloy ) property is fixed

# Multilayer thermal modeling method summary

- Current software is robust to predict TBC thickness and TBC thermal properties (not combination of thickness + conductivity)
  - Among two thermal properties and a thickness (total 3 parameters), only two parameters can be determined by thermal imaging methods
  
- For thermal property prediction, current results are probably ~10% higher, likely due to nonlinear temperature response of the infrared camera
  - This will be examined and corrected
  - Prediction accuracy of <5% is expected (similar accuracy as laser-flash method when testing stand-alone TBC specimens)
  
- Additional developments:
  - Improve accuracy for predicting both TBC thickness and conductivity
  - Improve optical models used for thermal imaging of natural TBCs (w/o black coat)
  - Evaluate prediction accuracy for thin and thick TBCs
  - Account for interface resistance (due to cracks)

## ■ Optical methods

- 3D optical coherence tomography (OCT)
  - *TBC thickness*
  - *3D TBC microstructure (and cracking)*
- 2D laser backscatter
  - *TBC degradation (cracking and delamination)*

## ■ Thermal imaging methods

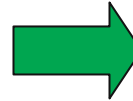
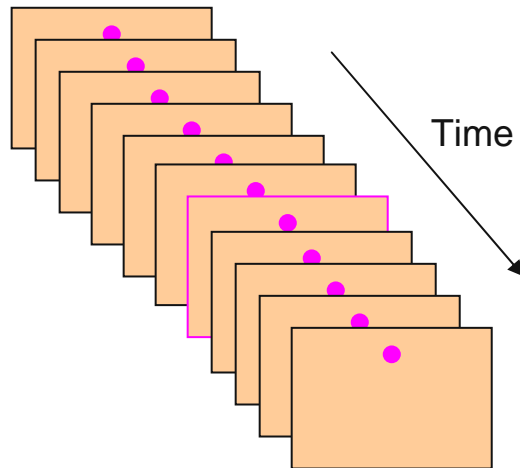
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# 3D Thermal Tomography Method

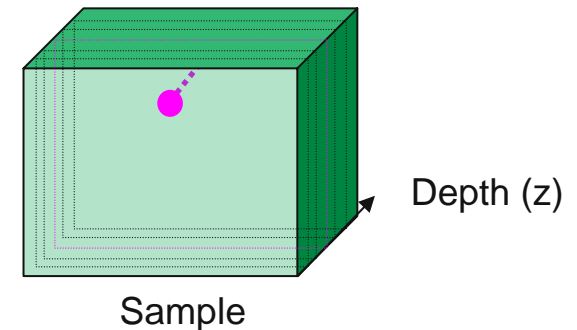
## Measured data $T(x,y,t)$ :

Time series of thermal  
(surface temperature) images



## Tomography results $e(x,y,z)$ :

3D spatial distribution of a material  
property within the sample



### ■ Thermal effusivity tomography technology:

- Convert measured thermal-imaging data  $T(x,y,t)$  into 3D material thermal-effusivity distribution  $e(x,y,z)$  [ $e = (\rho C_p k)^{1/2}$ ]
- $e(x,y,z)$  can be sliced in any planes (similar to x-ray CT slices)

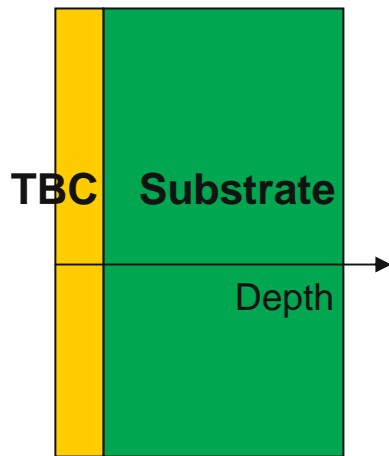
### ■ A new technology, US patent 7,365,330 issued in April, 2008

# Thermal Tomography Result for a Simulated TBC System

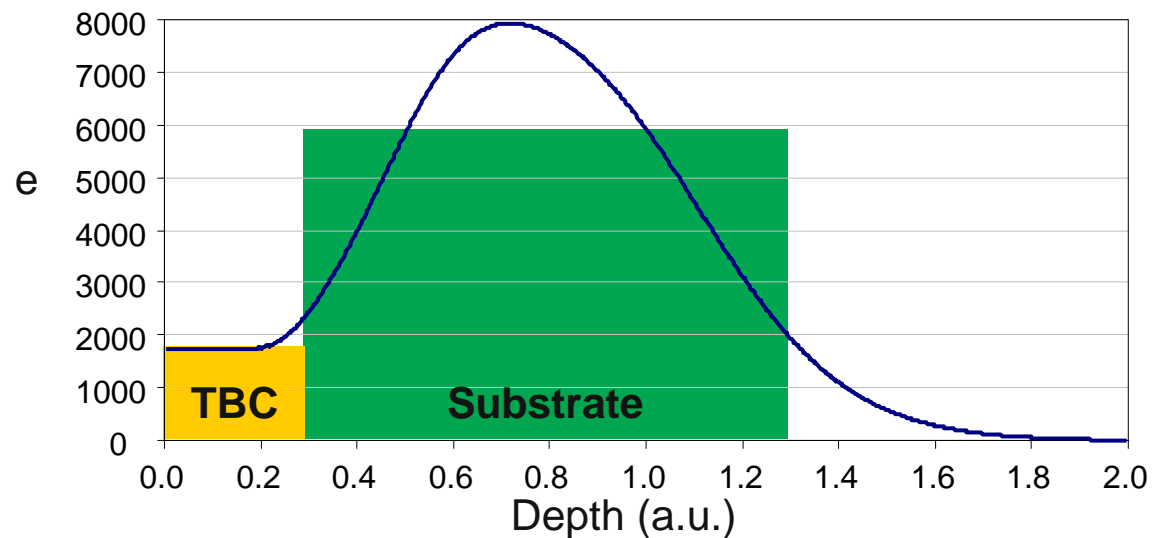
Material properties for a simulated TBC system

	L(mm)	k(W/m-K)	$\rho C_p$ (J/cm <sup>3</sup> -K)	e(J/m <sup>2</sup> -K-s <sup>1/2</sup> )	$\alpha$ (mm <sup>2</sup> /s)
TBC	0.3	1	3	1732	0.33
Substrate	3	10	3.5	5916	2.86

Two-layer opaque TBC



Predicted effusivity distribution along depth

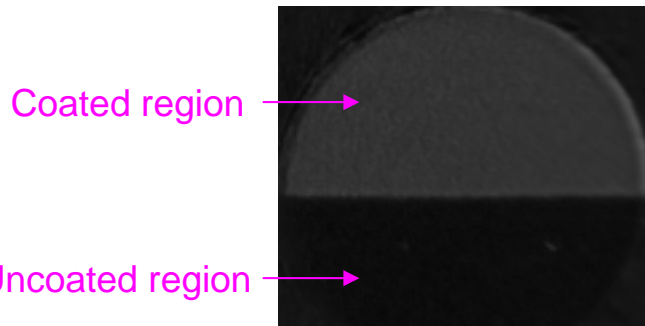


- Thermal diffusion reduces resolution in substrate
- Methods to improve resolution are being investigated

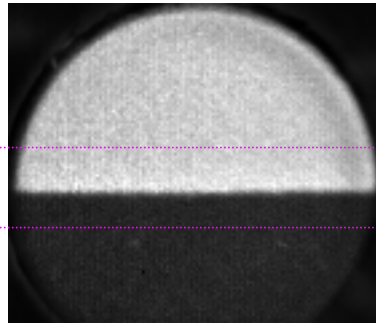
# Thermal tomography imaging for as-processed APS TBC

## Thermal Effusivity Plane images

At depth around half TBC thickness

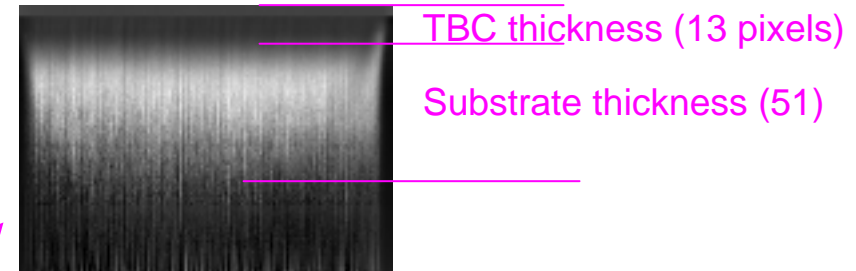


At depth around half substrate thickness

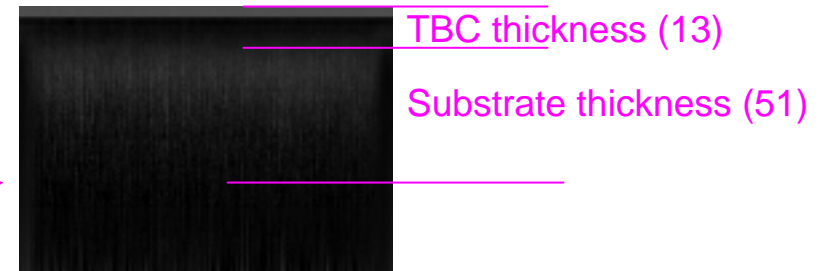


## Thermal Effusivity Cross-Sectional Images

In coated region



In uncoated region



- TBC translucency affects derived thermal effusivity values for TBC
- Depth resolution for TBC: 22.5  $\mu\text{m}/\text{pixel}$ ; for substrate: 62.4  $\mu\text{m}/\text{pixel}$

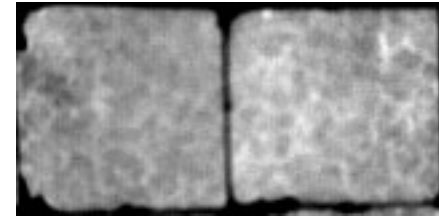
# Thermal tomography results for a thick TBC



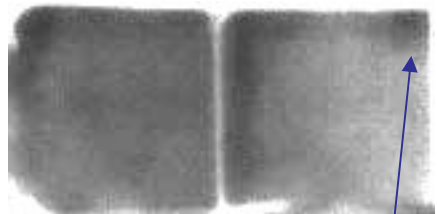
Sample courtesy  
of Dr. Derek Allen  
Alstom, England

TBC thickness = 2 mm  
Substrate thickness = 4 mm

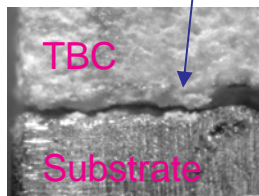
Typical raw thermal image ( $t=0.024s$ )



Rescaled plane data



Debond



TBC

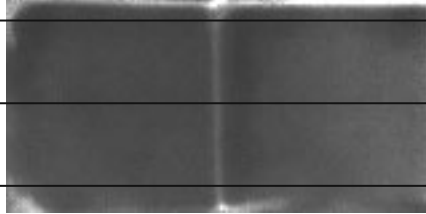
Substrate

Processed plane data

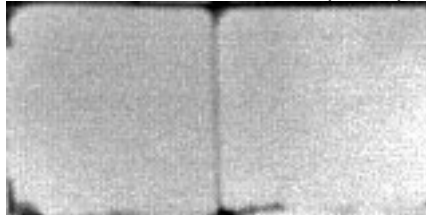
Within TBC (F15)



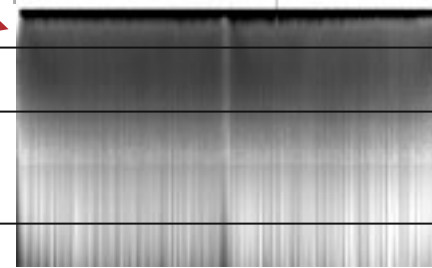
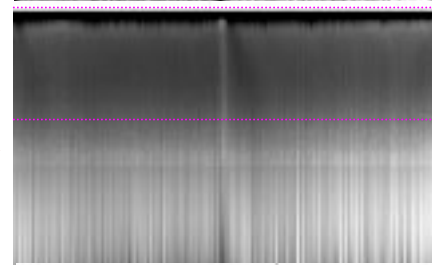
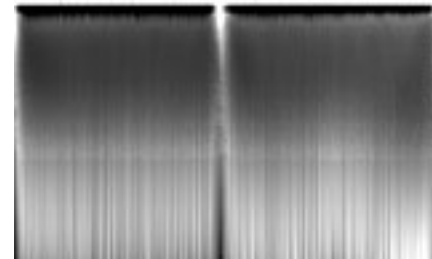
At interface (F37)



Within substrate (F80)



Processed cross-section data

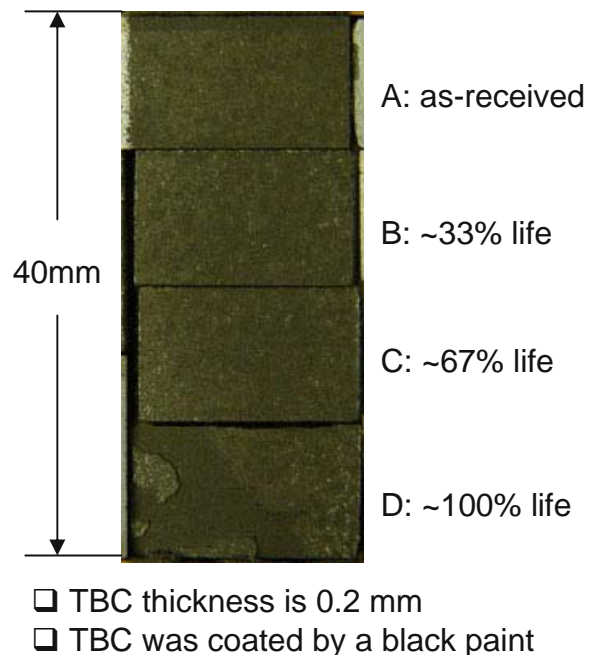


TBC thickness:  
2 mm (39 pixels)

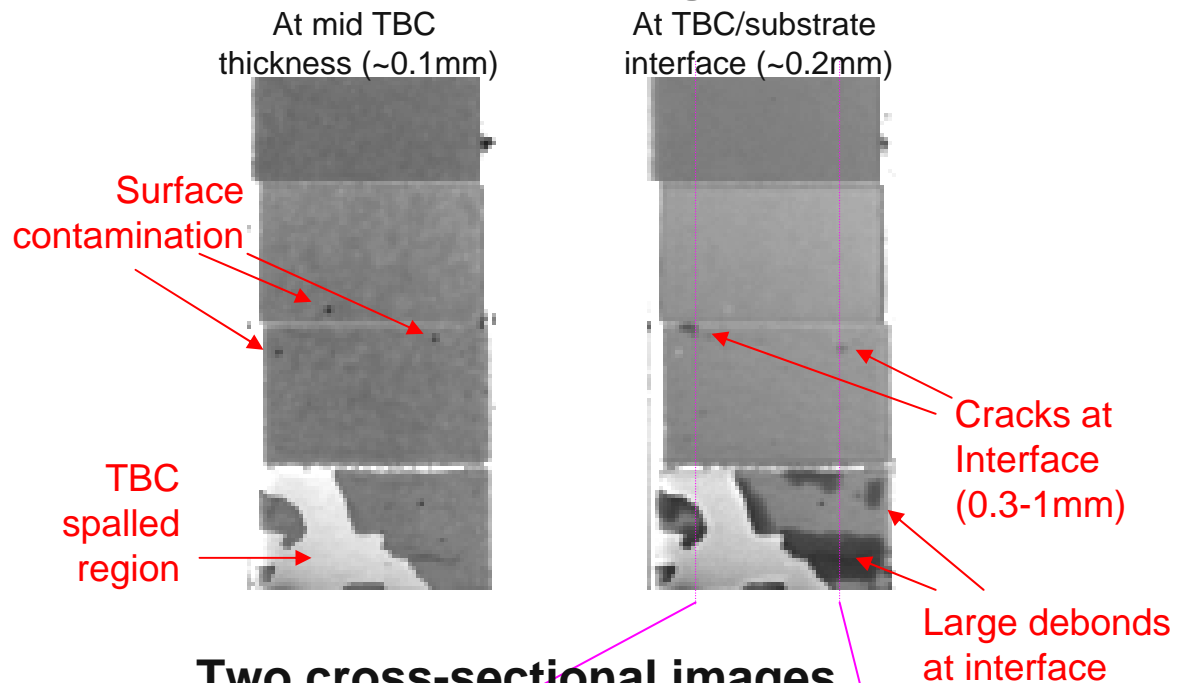
TBC: 2 mm  
Substrate: 4 mm

# Thermal tomography imaging for thermal-cycled TBCs

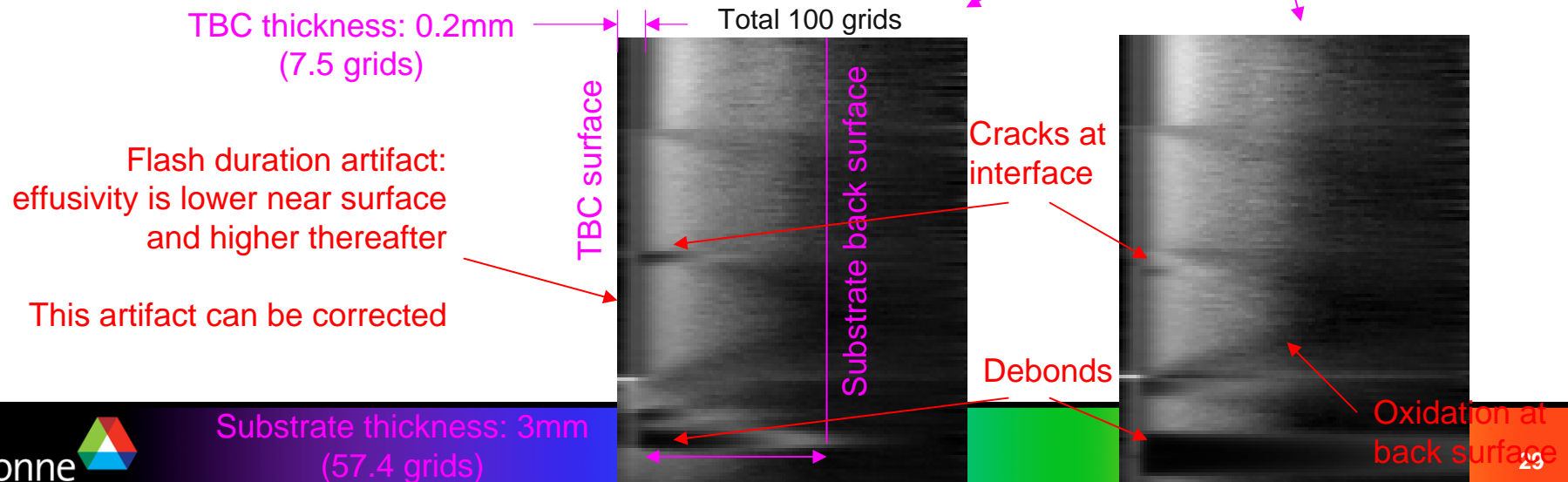
## 4 EBPVD TBC samples



## Two plane images



## Two cross-sectional images



## Thermal tomography method summary

- Thermal tomography is robust for 3D imaging of TBC systems – direction determination of TBC parameters: thickness and thermal properties
  - US patent 7,365,330 issued in April, 2008
  - Software is being copyrighted
  - Considerable interests for this technology from industry
  
- Additional developments
  - Correct flash duration effect which affects imaging of thin TBCs
  - Evaluate/correlate TBCs with various microstructure (layered) and defects
  - Improve spatial resolution in depth direction
  - Improve spatial resolution in lateral direction

## Summary

- 2D and 3D NDE methods were developed for quantitative imaging of TBC parameters – thickness and thermal property; preliminary results were obtained
  - (1) OCT method
    - *3D imaging of coating microstructure (needs refractive index for depth scale)*
    - *Max. detection depth depends on light wavelength and TBC microstructure*
  - (2) Thermal multilayer modeling method
    - *2D imaging of TBC thickness and/or TBC thermal property*
    - *Current model valid for opaque TBCs (and thick translucent TBCs)*
  - (3) Thermal tomography method
    - *3D imaging subsurface coating thermal property (effusivity)*
    - *Direct visual identification of TBC thickness*
- These NDE methods can be used to monitor TBC degradation/delamination and to predict TBC lifetime
- Thermal methods are capable for fast imaging of large complex components

## Planned Future Efforts

- Further developments of these NDE methods
  - Issues and correction approaches for each method were identified
  - Prediction accuracy of within 5% is targeted
  - Capable to image various TBC structures: thin/thick, graded/layered, opaque/translucent
- Validation of NDE methods for TBC degradation monitoring
  - Comparison with destructive examination results
  - Verification of data accuracy
  - Correlation of TBC parameter change to degradation “level”
- Correlation of NDE data between all methods